



Material Content Data Sheet



Halogen-Free

Sales Product Name	BSC050N04LS G	Issued	11. April 2021
MA#	MA001831308		
Package	PG-TDSON-8-40	Weight*	112.08 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.426	1.27	1.27	12725	12725
leadframe	inorganic material	phosphorus	7723-14-0	0.015	0.01		130	
	non noble metal	iron	7439-89-6	0.049	0.04		435	
	non noble metal	copper	7440-50-8	48.649	43.41	43.46	434046	434611
wire	non noble metal	copper	7440-50-8	0.048	0.04	0.04	428	428
encapsulation	organic material	carbon black	1333-86-4	0.083	0.07		744	
	plastics	epoxy resin	-	6.588	5.88		58777	
	inorganic material	silicondioxide	60676-86-0	35.025	31.25	37.20	312486	372007
leadfinish	non noble metal	tin	7440-31-5	1.520	1.36	1.36	13562	13562
plating	noble metal	silver	7440-22-4	0.158	0.14	0.14	1414	1414
solder	non noble metal	tin	7440-31-5	0.032	0.03		284	
	noble metal	silver	7440-22-4	0.040	0.04		355	
	non noble metal	lead	7439-92-1	1.518	1.35	1.42	13547	14186
heat sink CLIP	inorganic material	phosphorus	7723-14-0	0.005			45	
	non noble metal	iron	7439-89-6	0.017	0.02		151	
	non noble metal	copper	7440-50-8	16.910	15.09	15.11	150871	151067
*deviation	< 10%	Sum in total:				100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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